


PATENT NUMBER

U.S. UTILITY PATENT APPLICATION

O.I.P.E. m7k SCANNED <u>582</u> Q.A. <u>4</u>	PATENT DATE
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APPLICATION NO. 09/380312	CONT/PRIOR D F	CLASS 257	SUBCLASS G07	ART UNIT -2811	EXAMINER 
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APPLICANTS

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TITLE

Resin molded type semiconductor device 0.0001 0.0001

manufacturing the same 0.0001 0.0001

PTO-2040
12/89

PREPARED AND APPROVED FOR ISSUE

[illegible]

<input type="checkbox"/> TERMINAL DISCLAIMER	DRAWINGS		CLAIMS ALLOWED	
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims
<input type="checkbox"/> a) The term of this patent subsequent to _____ (date) has been disclaimed.	_____ (Assistant Examiner)		_____ (Date)	
<input type="checkbox"/> b) The term of this patent shall not extend beyond the expiration date of U.S. Patent. No. _____ _____ _____	_____ (Primary Examiner)		_____ (Date)	
<input type="checkbox"/> c) The terminal _____ months of this patent have been disclaimed.	_____ (Local Instruments Examiner)		_____ (Date)	
			NOTICE OF ALLOWANCE MAILED	
			ISSUE FEE	
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